
Hassan Al Faiz Mohamed awarded Mercedes-Benz scholarship

26 March 2019

Universiti Malaysia Pahang (UMP) undergraduate from the Faculty of Mechanical Engineering & Manufacturing (FKMP), Hassan Al Faiz Mohamed Ahmed Hafez – who is undergoing the dual-degree programme coordinated by UMP and HsKA University of Applied Sciences of Germany, for a Bachelor's Degree (Honors) in Automotive Engineering – lucked out when he was selected to be the recipient of the Mercedes-Benz (Malaysia) Sdn Bhd (MBM) scholarship for the duration of his baccalaureate.

According to the Department of Industry Partnership and Community Relations (ICoN), only 11 out of the 21 applicants were shortlisted for the final assessment by MBM, and Hassan Al Faiz Mohamed won the hearts of the selection committee.

Hassan Al Faiz Mohamed, 21, said he did not expect to win the scholarship, but nevertheless, was thankful to MBM for the opportunity and honour.

"I will definitely undertake to do my very best and study hard," he said jubilantly.

At a presentation ceremony held at the MBM's production plant in Pekan on March 13, 2019, Hassan Al Faiz Mohamed signed the scholarship acceptance agreement with MBM Deputy Vice-President, Patrick Baur, and the company's Human Resources General Manager, Norlida Sharif, in the presence of Deputy Vice-Chancellor (Academic & International), Professor Ir. Dr. Wan Azhar Wan Yusoff.

Also present at the signing ceremony were the Dean of FKMP, Professor Dr. Rizalman Mamat, and the faculty's lecturer, Dr. Mohd Hasnun Arif Hassan.

"Mercedes-Benz (Malaysia) Sdn. Bhd. is proud to award this prestigious scholarship to Hassan Al Faiz Mohamed. He is our second recipient from UMP, after Usamah Shamsudin, who graduated with a Bachelor's Degree (Honors) in Mechatronics in 2017," said Baur.

Meanwhile, Professor Ir. Dr. Wan Azhar, said the university wished to extend its heartfelt gratitude to MBM for the latter's due recognition of UMP's undergraduates, as well as for the continuous collaborations with the university in the fields of research, technical support, academic and human capital developments via the industry scholarships offering to the undergraduates of the dual-degree programme.

